

CMOS 32-bit Single Chip Microcomputer

- 32-bit C33 ADV RISC Core with 8K-byte Cache
- Low Power Consumption
- Multiply Accumulation
- Built-in 32K-byte + 1K-byte RAM
- 10-bit ADC
- 4-ch. SIO
- 10-ch. PWM Timer with DA16 Mode
- Card Interfaces
- High-speed DMA, Intelligent DMA

■ DESCRIPTIONS

The S1C33401 is a 32-bit RISC-type microcomputer originally developed for embedded applications by Seiko Epson. The S1C33401 is built around the C33 ADV core block that includes the CPU, MMU, cache, and modules that allow various external memory and I/O devices to be connected directly, and incorporates a bus block that includes the DMA controller and other control units. In addition to these primary units, the S1C33401 incorporates a basic peripheral circuit block that includes an interrupt controller, timers, serial interfaces, card interfaces, input/output ports, and A/D converter, and an extended peripheral circuit block that includes a chip ID register, RTC, and other components. The S1C33401 is manufactured by a 0.18 μm fine-pattern CMOS process, backed by sophisticated clock control functions, and can operate at higher speed with less power than ever before. In addition to its use as an embedded-type processor in various portable systems, the S1C33401 features a built-in C33 ADV CPU to provide enhanced functionality for multimedia support while retaining upward compatibility with the conventional C33 STD CPU, making it an ideal solution to the requirements of mobile multimedia applications.

Product Lineup

Model No.	Package
S1C33401F00A***	QFP20-184pin
S1C33401B00A***	PFBGA-160pin

■ FEATURES

CORE

● CPU

- Original Seiko Epson 32-bit RISC-type CPU – C33 ADV
- Internal 32-bit data processing
- 4GB address space
- Powerful instruction set
 - Code length: 16 bits per instruction
 - Number of instructions: 164
 - Main instructions executable in 1 cycle (including immediate-extended instructions, each consisting of two to three instructions)
 - 15.15 ns per instruction (when operating at 66 MHz, max.)
- Multimedia support functions
 - Built-in 32-bit \times 16-bit multiplier
 - 16 \times 16, 32 \times 16 and 32 \times 32-bit multiplication
 - 16 \times 16, 32 \times 16 and 32 \times 32-bit multiply-accumulate operations
 - Repeated execution by loop and repeat instructions
 - Rounding to minimum/maximum values by saturation instruction
 - ALU instruction execution with post-shift

● High-speed Bus Control Unit (HBCU)

- Controls memory access by the CPU by dividing 4GB logical space into eight 512MB blocks.
- Manages MMU, CCU, and ASID processing in each block.
- Capable of multiplexing logical space using ASID and mirroring physical space.
- Can simultaneously process A0RAM data read/write operations and instruction fetching from cache.

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● Memory Management Unit (MMU)

- Converts logical space into physical space in page units (4KB or 64KB per page).
- Supports 16 entries per way for a total of 64 entries, due to 4-way set associative method.
- Can protect memory for each page.
- Allows optional selection of using cache for each page.
- Supports five causes of MMU exception.

● Cache Control Unit (CCU)

- Physical address-based instruction/data coexisting type of cache
- Contains 8KB cache.
- Supports 128 entries per way for a total of 512 lines, due to 4-way set associative method (4 words per line).
- Allows selection of write-through or write-back mode for writing to cache.
- Can lock a specified way and interrupt handler routine.
- Forwarding function to allow immediate instruction/data transfer even during refill.

● Clock Management Unit (CMU)

- Controls reset and NMI input.
- System clock control
 - Selects clock source, turns clock on/off, and divides operating clock.
 - Controls clock according to standby mode (SLEEP, HALT, or HALT2).
- Controls clock supply for each module (manual/auto).

● Debug Unit (DBG)

- Supports on-chip trace/break and other debugging functions at the chip level.
- Provides an advanced debugging environment in conjunction with the ICD (in-circuit debugger) and debugger.

INTERNAL MEMORY

● High-speed RAM Incorporated in Area 0 (A0RAM)

- 32KB
- High-speed access with zero wait state

● RAM Incorporated in Area 3 (A3RAM)

- 1KB
- Access with one wait state
- Also usable as IDMA control information table

BUS CONTROL UNITS AND DMA CONTROLLER

● Basic Bus Control Unit (BBCU)

- Controls external address space by dividing it into 19 areas (Areas 4 to 22).
- Allows selection of external/internal access, endian mode, interface mode, device type, device size, and number of access cycles for each area.
- Outputs 8 chip-enable signals (#CE4–#CE11) corresponding to each external area.
- Supports two interface modes: A0 and BSL (with BSL mode for external memory only).
- Allows direct connection of SRAM, ROM, burst ROM, or flash memory to external bus.
- Allows insertion of wait state from external #WAIT pin (for SRAM type only).
- Arbitrates bus contention with external bus masters.

● Extended Bus Control Unit (EBCU)

- Allows direct connection of SDRAM (in one of Areas 4 to 22 selected).
- Data bus width: 16 bits
- Bank address: Up to four banks accommodated.
- Burst length: Fixed to 1 (with burst read/write executed by issuing successive commands).
- CAS latency: 1, 2, or 3
- Write mode: Single write
- Supports self-refresh and auto-refresh.
- Programmable refresh cycle
- Allows selection of bank active mode (with or without auto-precharge).

● High-speed DMA Controller (HSDMA)

- Up to four channels
- Capable of high-speed DMA transfer because of no need to read/write transfer conditions, etc. from/to memory.
- Supports dual-address and single-address transfers.
- Activated by DMA request input, interrupt cause, or software trigger.
- Can generate interrupt upon completion of transfer.

● Intelligent DMA Controller (IDMA)

- Up to 128 channels
- Supports dual-address transfers.
- Programmable DMA transfer control information in RAM (except A0RAM)
- Activated by a specific interrupt cause or software trigger.
- Can be linked from one IDMA channel to another.
- Can generate an interrupt upon completion of transfer.

INTERNAL PERIPHERAL CIRCUITS

● OSC3 Oscillator Circuit

- Generates the main system clock.
- Crystal/ceramic oscillator: 5 MHz (min.) to 33 MHz (max.)
- External clock input: 2 MHz (min.) to 33 MHz (max.)

● PLL

- Allows selection of whether to use $\times 1$ to $\times 16$ OSC3 oscillation frequency.
- PLL input frequency: 5 MHz (min.) to 33 MHz (max.)
- PLL output frequency: 20 MHz (min.) to 66 MHz (max.)

● SSCG (Spread Spectrum Clock Generator)

- SS-modulation circuit for system source clock (OSC3, PLL, or OSC1) to reduce Electromagnetic Interference (EMI) noise

● Interrupt Controller (ITC)

- Branches to interrupt handling routine via interrupt vector table.
- Can activate intelligent DMA.
- Handles 9 exceptions:
 - Reset exception (1)
 - Divide by zero exception (1)
 - Address misaligned exception (1)
 - NMI (1)
 - Software exceptions (4)
 - MMU exception (1)
- Handles 64 maskable interrupts:
 - Port/key input interrupts (18)
 - DMA controller interrupts (5)
 - 16-bit timer interrupts (20)
 - 8-bit timer interrupts (6)
 - Serial interface interrupts (12)
 - A/D converter interrupts (2)
 - RTC interrupt (1)

● Prescaler (PSC)

- Programmable 8-bit and 16-bit timers, and A/D converter clock settings

● 8-bit Timer (T8)

- 6-channel, 8-bit programmable timers
- Can generate an interrupt upon underflow.
- Can output the clock generated by underflow to external devices.
- Generates serial interface clock as programmed.
- Can output a trigger to A/D converter at specified intervals.

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● 16-bit Timer (T16)

- 10-channel, 16-bit programmable timers
- Can be used as PWM timer.
- Supports DA16 mode.
- Can generate two interrupts per channel upon underflow or when matching compared value.
- Can output clock generated by underflow or when matching compared value to external devices.

● Watchdog Timer (WDT)

- 30-bit watchdog timer capable of generating NMI
- Programmable setting of NMI generation cycle

● Serial Interface (SIO)

- 4 channels
- Contains 4-byte receive data buffer (FIFO) and 2-byte transmit data buffer (FIFO) for each channel.
- Supports full-duplex communication.
- Selectable between 8-bit clock-synchronous and 8-bit or 7-bit asynchronous modes.
- Supports IrDA 1.0 interface.
- Can generate transmit buffer empty, receive buffer full, and receive error interrupts.

● Card Interface (CARD)

- Supports SmartMedia card (NAND flash).
- Supports CompactFlash card.
- Supports PC card (2 channels).

● I/O Ports (PORT)

- Up to 71 ports
- Can be used as general-purpose I/O pins when not used for peripheral functions.
- Programmable port input and key input interrupts

● A/D Converter (ADC)

- 4-channel, 10-bit A/D converters
- Can generate an interrupt upon completion of conversion.
- Can generate an interrupt when converted value is outside specified upper and lower limits.

● RTC

- Contains BCD time (second, minute, and hour) counters and calendar (day, days of the week, month, and year) counters.
- Allows selection between 24-hour and 12-hour modes.
- Equipped with function for 30-second correction in software.
- Can periodically generate interrupts (at intervals of 1/64 or 1 second, 1 minute, or 1 hour).
- Powered independently of other modules, and can operate even when system power is turned off.
- Contains an OSC1 oscillator circuit to generate 32.768 kHz (typ.) clock.

OPERATING CONDITIONS AND POWER CONSUMPTION

● Power Supply Voltage

- Core power supply voltages (V_{DD} , PLL_{VDD} , RTC_{VDD}): 1.65 V to 1.95 V (1.8 V \pm 0.15 V)
- I/O power supply voltages (V_{DDE} , TM_{VDD} , AV_{DD}): 2.70 V to 3.60 V (3.0/3.3 V \pm 0.3 V)

● Input Voltage

- High-level input voltage: 2.20 V (min.) to V_{DDE} (max.)
- Low-level input voltage: V_{SS} (min.) to 0.80 V (max.)

● Operating Clock Frequency

- CPU: 66 MHz (max.)
- Bus (BBCU, EBCU): 66 MHz (max.)

● Operating Temperature

- -40°C to 85°C

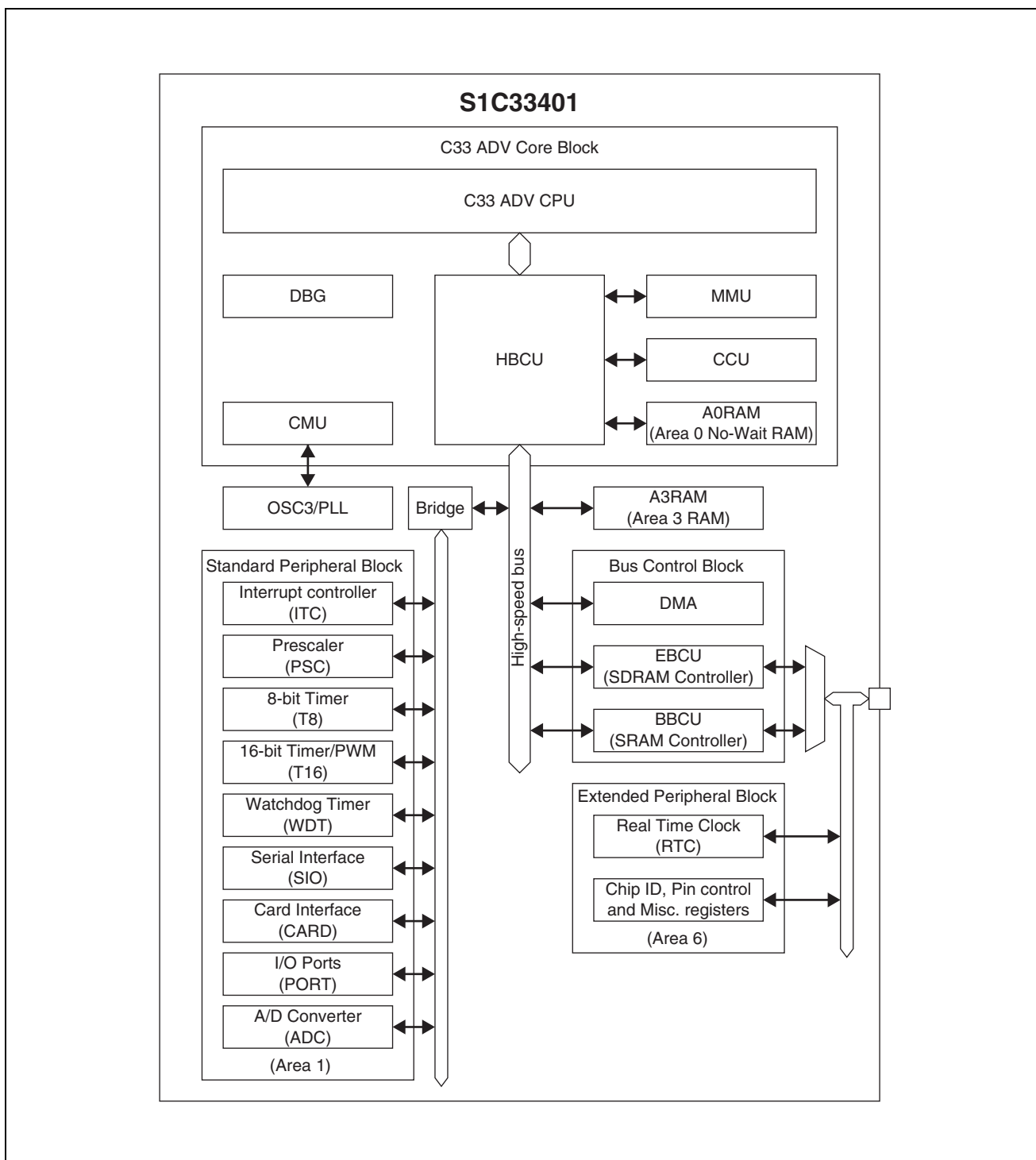
● Power Consumption

- In SLEEP mode: 25 μ W (typ.)
- In HALT mode: 36 mW (typ., 66 MHz)
- During operation: 65 mW (typ., 66 MHz, cache off)

FORM OF SHIPMENT

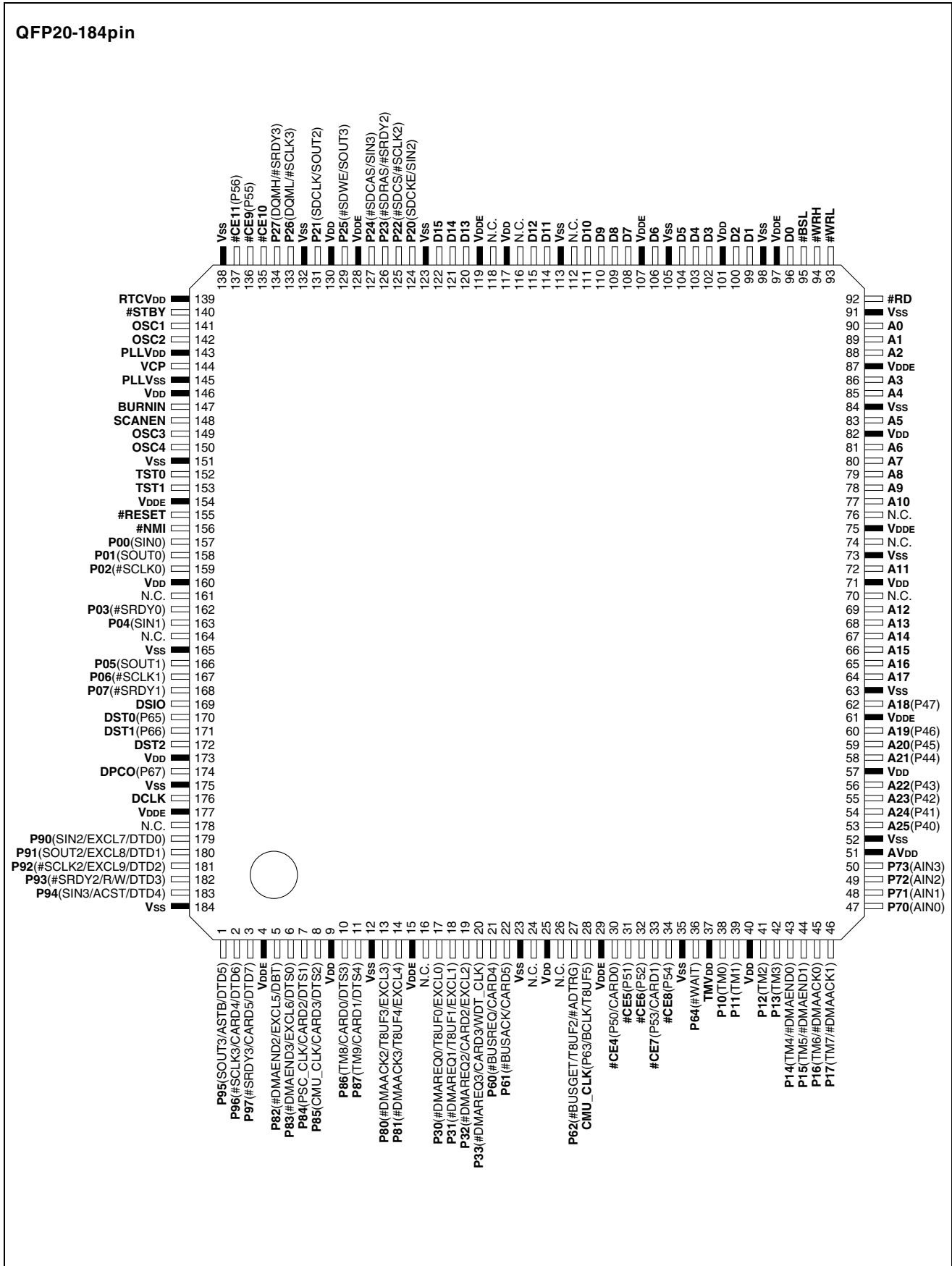
- PFBGA 160-pin plastic package (10 mm \times 10 mm \times 1.2 mm, 0.65 mm pitch)
- QFP20 184-pin plastic package (20 mm \times 20 mm \times 1.7 mm, 0.40 mm pitch)

■ BLOCK DIAGRAM

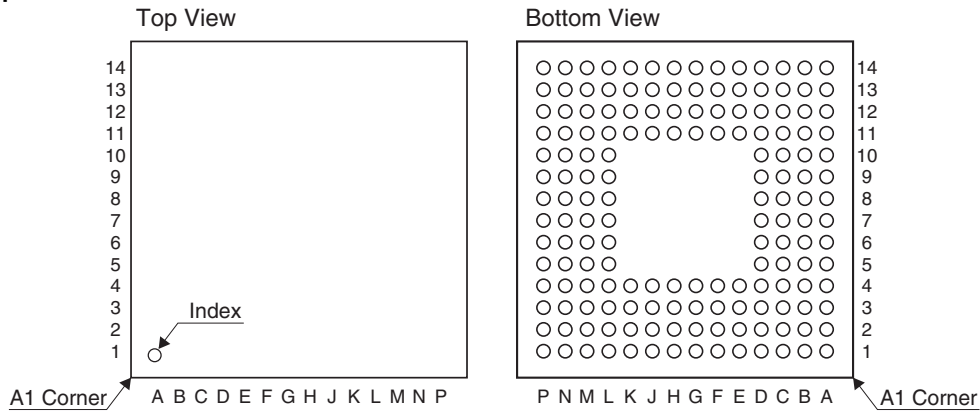


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PIN LAYOUT DIAGRAM



PFBGA-160pin



	1	2	3	4	5	6	7	8	9	10	11	12	13	14							
A		P92 #SCLK2 EXCL9 N.C., DTD2	P90 SIN2 EXCL7 DTD0	DCLK	P66 DST1	P06 #SCLK1	P03 #SRDY0	P00 SIN0	OSC4	OSC3	Vss	OSC2	OSC1		N.C.						
B	P95 SOUT3 ASTB DTD5	P93 #SRDY2 R/W DTD3	P91 SOUT2 EXCL8 DTD1	P67 DPCO	P65 DST0	P05 SOUT1	VDD	#NMI	TST1	SCANEN	VDD	RTCVDD	#STBY	Vss							
C	P97 #SRDY3 CARD5 DTD7	P96 #SCLK3 CARD4 DTD6	Vss	P94 SIN3 ACST DTD4	DSIO	P07 #SRDY1	P04 SIN1	P01 SOUT0	TST0	BURNIN	VCP	PLLVDd	#CE10	P27 DQMH #SRDY3							
D	P84 PSC_CLK CARD2 DTS1	P83 #DMAEND3 EXCL6 DTS0	P82 #DMAEND2 EXCL5 DBT	VDDDE	DST2	Vss	P02 #SCLK0	#RESET	VDDDE	#CE11 P56	PLLVss	P26 DQML #SCLK3	Vss	P21 SDCLK SOUT2							
E	P86 TM8 CARD0 DTS3	Vss	P85 CMU_CLK CARD3 DTS2	VDD	Top View						#CE9 P55	P25 #SDWE SOUT3	P24 #SDCAS SIN3	VDDDE							
F	P81 #DMAACK3 T8UF4 EXCL4	P30 #DMAREQ0 T8UF0 EXCL0	P87 TM9 CARD1 DTS4	P80 #DMAACK2 T8UF3 EXCL3													VDD	P23 #SDRAS #SRDY2	D15	P20 SDCKE SIN2	
G	P32 #DMAREQ2 CARD2 EXCL2	P61 #BUSACK CARD5	P31 #DMAREQ1 T8UF1 EXCL1	P33 #DMAREQ3 CARD3 WDT_CLK													P22 #SDCS #SCLK2	D13	D14	VDD	
H	CMU_CLK P63 BCLK T8UF5	P62 #BUSGET T8UF2 #ADTRG	P60 #BUSREQ CARD4	VDDDE													VDDDE	D11	D12	Vss	
J	#CE6 P52	#CE5 P51	#CE7 P53 CARD1	#CE4 P50 CARD0													D9	D8	D10	D7	
K	P64 #WAIT	TMVDD	Vss	#CE8 P54							Vss	D4	D6	D5							
L	P11 TM1	P12 TM2	P13 TM3	P10 TM0	VDD	A21 P44	A16	Vss	A6	A4	D3	VDD	D2	D1							
M	P14 TM4 #DMAEND0	P16 TM6 #DMAACK0	P17 TM7 #DMAACK1	P15 TM5 #DMAEND1	A23 P42	VDDDE	A14	A11	A9	Vss	#WRL	#WRH	#BSL	D0							
N	P70 AIN0	P71 AIN1	AVDD	A25 P40	A22 P43	A19 P46	A17	A13	A8	A5	VDDDE	A1	Vss	#RD							
P		P72 AIN2	P73 AIN3	A24 P41	A20 P45	A18 P47	A15	A12	A10	A7	A3	A2	A0		N.C.						
	1	2	3	4	5	6	7	8	9	10	11	12	13	14							

■ PIN DESCRIPTION

Power Supply Pin List

Pin name	Pin No.		Function
	QFP	PFBGA	
V _{DD}	9,25,40,57,71,82,101,117,130,146,160,173	B7,B11,E4,F11,G14,L5,L12	Power supply (+) for the internal logic circuits (1.65 V to 1.95 V)
V _{SS}	12,23,35,52,63,73,84,91,98,105,113,123,132,138,151,165,175,184	A11,B14,C3,D6,D13,E2,H14,K3,K11,L8,M10,N13	Power supply (-); GND
PLL _{VDD}	143	C12	Power supply (+) for the PLL (PLL _{VDD} = V _{DD})
PLL _{VSS}	145	D11	Power supply (-) for the PLL (PLL _{VSS} = V _{SS})
RTC _{VDD}	139	B12	Power supply (+) for the RTC (RTC _{VDD} = V _{DD})
V _{DDE}	4,15,29,61,75,87,97,107,119,128,154,177	D4,D9,E14,H4,H11,M6,N11	Power supply (+) for the I/O block (2.7 V to 3.6 V)
TM _{VDD}	37	K2	Power supply (+) for PWM timer outputs (P1x port) (TM _{VDD} = V _{DDE})
AV _{DD}	51	N3	Power supply (+) for the analog system and AIN0-AIN3 (AV _{DD} = V _{DDE})

External Bus Pin List

Pin name	Pin No.		I/O	Pull-up	Function	Module
	QFP	PFBGA				
D[15:0]	122-120,115,114,111-108,106,104-102,100,99,96	F13,G13,G12,H13,H12,J13,J11,J12,J14,K13,K14,K12,L11,L13,L14,M14	I/O	*2	Data bus (D15-D0)	BBCU EBCU
#BSL	95	M13	O	*1	Bus strobe (low byte) signal in BSL mode	BBCU
#RD	92	N14	O	*1	Read signal	BBCU
#WRL	93	M11	O	*1	Write (low byte) signal in A0 mode or write signal in BSL mode	BBCU
#WRH	94	M12	O	*1	Write (high byte) signal in A0 mode or Bus strobe (high byte) signal in BSL mode	BBCU
A[17:0]	64-69,72,77-81,83,85,86,88-90	N7,L7,P7,M7,N8,P8,M8,P9,M9,N9,P10,L9,N10,L10,P11,P12,N12,P13	O	*1	Address bus (A17-A0)	BBCU EBCU
A18 P47	62	P6	I/O	*1	A18: Address bus (A18) (default) P47: General-purpose I/O port	BBCU PORT
A19 P46	60	N6	I/O	*1	A19: Address bus (A19) (default) P46: General-purpose I/O port	BBCU PORT
A20 P45	59	P5	I/O	*1	A20: Address bus (A20) (default) P45: General-purpose I/O port	BBCU PORT
A21 P44	58	L6	I/O	*1	A21: Address bus (A21) (default) P44: General-purpose I/O port	BBCU PORT
A22 P43	56	N5	I/O	*1	A22: Address bus (A22) (default) P43: General-purpose I/O port	BBCU PORT
A23 P42	55	M5	I/O	*1	A23: Address bus (A23) (default) P42: General-purpose I/O port	BBCU PORT
A24 P41	54	P4	I/O	*1	A24: Address bus (A24) (default) P41: General-purpose I/O port	BBCU PORT
A25 P40	53	N4	I/O	*1	A25: Address bus (A25) (default) P40: General-purpose I/O port	BBCU PORT
#CE11 P56	137	D10	I/O	*1	#CE11: Chip enable signal for areas 11 and 12 (default) P56: General-purpose I/O port	BBCU PORT
#CE10	135	C13	I/O	*1	Chip enable signal for areas 10, 13 and 20	BBCU
#CE9 P55	136	E11	I/O	*1	#CE9: Chip enable signal for areas 9 and 22 (default) P55: General-purpose I/O port	BBCU PORT
#CE8 P54	34	K4	I/O	*1	#CE8: Chip enable signal for areas 8 and 21 (default) P54: General-purpose I/O port	BBCU PORT

Pin name	Pin No.		I/O	Pull-up	Function	Module
	QFP	PFBGA				
#CE7 P53 CARD1	33	J3	I/O	*1	#CE7: Chip enable signal for areas 7 and 19 (default) P53: General-purpose I/O port CARD1:Card I/F signal 1 output (#SMWR or #CFCE2)	BBCU PORT CARD
#CE6 P52	32	J1	I/O	*1	#CE6: Chip enable signal for areas 6, 17 and 18 (default) P52: General-purpose I/O port	BBCU PORT
#CE5 P51	31	J2	I/O	*1	#CE5: Chip enable signal for areas 5, 15 and 16 (default) P51: General-purpose I/O port	BBCU PORT
#CE4 P50 CARD0	30	J4	I/O	*1	#CE4: Chip enable signal for areas 4 and 14 (default) P50: General-purpose I/O port CARD0:Card I/F signal 0 output (#SMRD or #CFCE1)	BBCU PORT CARD

Input/Output Port and Peripheral Circuit Pin List

Pin name	Pin No.		I/O	Pull-up	Function	Module
	QFP	PFBGA				
P00 SIN0	157	A8	I/O	*1	P00: General-purpose I/O port (default) SIN0: Serial I/F Ch.0 data input	PORT SIO
P01 SOUT0	158	C8	I/O	*1	P01: General-purpose I/O port (default) SOUT0: Serial I/F Ch.0 data output	PORT SIO
P02 #SCLK0	159	D7	I/O	*1	P02: General-purpose I/O port (default) #SCLK0: Serial I/F Ch.0 clock input/output	PORT SIO
P03 #SRDY0	162	A7	I/O	*1	P03: General-purpose I/O port (default) #SRDY0: Serial I/F Ch.0 ready signal input/output	PORT SIO
P04 SIN1	163	C7	I/O	*1	P04: General-purpose I/O port (default) SIN1: Serial I/F Ch.1 data input	PORT SIO
P05 SOUT1	166	B6	I/O	*1	P05: General-purpose I/O port (default) SOUT1: Serial I/F Ch.1 data output	PORT SIO
P06 #SCLK1	167	A6	I/O	*1	P06: General-purpose I/O port (default) #SCLK1: Serial I/F Ch.1 clock input/output	PORT SIO
P07 #SRDY1	168	C6	I/O	*1	P07: General-purpose I/O port (default) #SRDY1: Serial I/F Ch.1 ready signal input/output	PORT SIO
P10 TM0	38	L4	I/O	*1	P10: General-purpose I/O port (default) TM0: 16-bit timer 0 output	PORT T16
P11 TM1	39	L1	I/O	*1	P11: General-purpose I/O port (default) TM1: 16-bit timer 1 output	PORT T16
P12 TM2	41	L2	I/O	*1	P12: General-purpose I/O port (default) TM2: 16-bit timer 2 output	PORT T16
P13 TM3	42	L3	I/O	*1	P13: General-purpose I/O port (default) TM3: 16-bit timer 3 output	PORT T16
P14 TM4 #DMAEND0	43	M1	I/O	*1	P14: General-purpose I/O port (default) TM4: 16-bit timer 4 output #DMAEND0: HSDMA Ch.0 end-of-transfer signal output	PORT T16 HSDMA
P15 TM5 #DMAEND1	44	M4	I/O	*1	P15: General-purpose I/O port (default) TM5: 16-bit timer 5 output #DMAEND1: HSDMA Ch.1 end-of-transfer signal output	PORT T16 HSDMA
P16 TM6 #DMAACK0	45	M2	I/O	*1	P16: General-purpose I/O port (default) TM6: 16-bit timer 6 output #DMAACK0: HSDMA Ch.0 acknowledge signal output	PORT T16 HSDMA
P17 TM7 #DMAACK1	46	M3	I/O	*1	P17: General-purpose I/O port (default) TM7: 16-bit timer 7 output #DMAACK1: HSDMA Ch.1 acknowledge signal output	PORT T16 HSDMA
P20 SDCKE SIN2	124	F14	I/O	*1	P20: General-purpose I/O port (default) SDCKE: SDRAM clock enable signal output SIN2: Serial I/F Ch.2 data input	PORT EBCU SIO
P21 SDCLK SOUT2	131	D14	I/O	*1	P21: General-purpose I/O port (default) SDCLK: SDRAM clock output SOUT2: Serial I/F Ch.2 data output	PORT EBCU SIO
P22 #SDCS #SCLK2	125	G11	I/O	*1	P22: General-purpose I/O port (default) #SDCS: SDRAM chip enable signal output #SCLK2: Serial I/F Ch.2 clock input/output	PORT EBCU SIO
P23 #SDRAS #SRDY2	126	F12	I/O	*1	P23: General-purpose I/O port (default) #SDRAS: SDRAM row address strobe signal output #SRDY2: Serial I/F Ch.2 ready signal input/output	PORT EBCU SIO
P24 #SDCAS SIN3	127	E13	I/O	*1	P24: General-purpose I/O port (default) #SDCAS: SDRAM column address strobe signal output SIN3: Serial I/F Ch.3 data input	PORT EBCU SIO

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Pin name	Pin No.		I/O	Pull-up	Function	Module
	QFP	PFBGA				
P25 #SDWE SOUT3	129	E12	I/O	*1	P25: General-purpose I/O port (default) #SDWE: SDRAM write signal output SOUT3: Serial I/F Ch.3 data output	PORT EBCU SIO
P26 DQML #SCLK3	133	D12	I/O	*1	P26: General-purpose I/O port (default) DQML: SDRAM data (low byte) input/output mask signal output #SCLK3: Serial I/F Ch.3 clock input/output	PORT EBCU SIO
P27 DQMH #SRDY3	134	C14	I/O	*1	P27: General-purpose I/O port (default) DQMH: SDRAM data (high byte) input/output mask signal output #SRDY3: Serial I/F Ch.3 ready signal input/output	PORT EBCU SIO
P30 #DMAREQ0 T8UF0 EXCL0	17	F2	I/O	*1	P30: General-purpose I/O port (default) #DMAREQ0: HSDMA Ch.0 request input T8UF0: 8-bit timer 0 output EXCL0: 16-bit timer 0 event counter input	PORT HSDMA T8 T16
P31 #DMAREQ1 T8UF1 EXCL1	18	G3	I/O	*1	P31: General-purpose I/O port (default) #DMAREQ1: HSDMA Ch.1 request input T8UF1: 8-bit timer 1 output EXCL1: 16-bit timer 1 event counter input	PORT HSDMA T8 T16
P32 #DMAREQ2 CARD2 EXCL2	19	G1	I/O	*1	P32: General-purpose I/O port (default) #DMAREQ2: HSDMA Ch.2 request input CARD2: Card I/F signal 2 output (#IORD or #SMRD) EXCL2: 16-bit timer 2 event counter input	PORT HSDMA CARD T16
P33 #DMAREQ3 CARD3 WDT_CLK	20	G4	I/O	*1	P33: General-purpose I/O port (default) #DMAREQ3: HSDMA Ch.3 request input CARD3: Card I/F signal 3 output (#IOWR or #SMWR) WDT_CLK: Watchdog timer output	PORT HSDMA CARD WDT
P60 #BUSREQ CARD4	21	H3	I/O	*1	P60: General-purpose I/O port (default) #BUSREQ: Bus release request input CARD4: Card I/F signal 4 output (#OE or #CFCE1)	PORT BBCU CARD
P61 #BUSACK CARD5	22	G2	I/O	*1	P61: General-purpose I/O port (default) #BUSACK: Bus acknowledge output CARD5: Card I/F signal 5 output (#WE or #CFCE2)	PORT BBCU CARD
P62 #BUSGET T8UF2 #ADTRG	27	H2	I/O	*1	P62: General-purpose I/O port (default) #BUSGET: Bus status monitor signal output T8UF2: 8-bit timer 2 output #ADTRG: A/D converter trigger input	PORT BBCU T8 ADC
P64 #WAIT	36	K1	I/O	*1	P64: General-purpose I/O port (default) #WAIT: Wait cycle request input	PORT BBCU
P70 AIN0	47	N1	I	*1	P70: General-purpose I/O port (default) AIN0: A/D converter Ch.0 input	PORT ADC
P71 AIN1	48	N2	I	*1	P71: General-purpose I/O port (default) AIN1: A/D converter Ch.1 input	PORT ADC
P72 AIN2	49	P2	I	*1	P72: General-purpose I/O port (default) AIN2: A/D converter Ch.2 input	PORT ADC
P73 AIN3	50	P3	I	*1	P73: General-purpose I/O port (default) AIN3: A/D converter Ch.3 input	PORT ADC
P80 #DMAACK2 T8UF3 EXCL3	13	F4	I/O	*1	P80: General-purpose I/O port (default) #DMAACK2: HSDMA Ch.2 acknowledge signal output T8UF3: 8-bit timer 3 output EXCL3: 16-bit timer 3 event counter input	PORT HSDMA T8 T16
P81 #DMAACK3 T8UF4 EXCL4	14	F1	I/O	*1	P81: General-purpose I/O port (default) #DMAACK3: HSDMA Ch.3 acknowledge signal output T8UF4: 8-bit timer 4 output EXCL4: 16-bit timer 4 event counter input	PORT HSDMA T8 T16
P82 #DMAEND2 EXCL5 DBT	5	D3	I/O	*1	P82: General-purpose I/O port (default) #DMAEND2: HSDMA Ch.2 end-of-transfer signal output EXCL5: 16-bit timer 5 event counter input DBT: DBT signal output for debugging	PORT HSDMA T16 DBG
P83 #DMAEND3 EXCL6 DTS0	6	D2	I/O	*1	P83: General-purpose I/O port (default) #DMAEND3: HSDMA Ch.3 end-of-transfer signal output EXCL6: 16-bit timer 6 event counter input DTS0: DTS0 signal output for debugging	PORT HSDMA T16 DBG
P84 PSC_CLK CARD2 DTS1	7	D1	I/O	*1	P84: General-purpose I/O port (default) PSC_CLK: Prescaler clock output CARD2: Card I/F signal 2 output (#IORD or #SMRD) DTS1: DTS1 signal output for debugging	PORT PSC CARD DBG

Pin name	Pin No.		I/O	Pull-up	Function	Module
	QFP	PFBGA				
P85 CMU_CLK CARD3 DTS2	8	E3	I/O	*1	P85: General-purpose I/O port (default) CMU_CLK: CMU external clock output CARD3: Card I/F signal 3 output (#IOWR or #SMWR) DTS2: DTS2 signal output for debugging	PORT CMU CARD DBG
P86 TM8 CARD0 DTS3	10	E1	I/O	*1	P86: General-purpose I/O port (default) TM8: 16-bit timer 8 output CARD0: Card I/F signal 0 output (#SMRD or #CFCE1) DTS3: DTS3 signal output for debugging	PORT T16 CARD DBG
P87 TM9 CARD1 DTS4	11	F3	I/O	*1	P87: General-purpose I/O port (default) TM9: 16-bit timer 9 output CARD1: Card I/F signal 1 output (#SMWR or #CFCE2) DTS4: DTS4 signal output for debugging	PORT T16 CARD DBG
P90 SIN2 EXCL7 DTD0	179	A3	I/O	*1	P90: General-purpose I/O port (default) SIN2: Serial I/F Ch.2 data input EXCL7: 16-bit timer 7 event counter input DTD0: DTD0 signal output for debugging	PORT SIO T16 DBG
P91 SOUT2 EXCL8 DTD1	180	B3	I/O	*1	P91: General-purpose I/O port (default) SOUT2: Serial I/F Ch.2 data output EXCL8: 16-bit timer 8 event counter input DTD1: DTD1 signal output for debugging	PORT SIO T16 DBG
P92 #SCLK2 EXCL9 DTD2	181	A2	I/O	*1	P92: General-purpose I/O port (default) #SCLK2: Serial I/F Ch.2 clock input/output EXCL9: 16-bit timer 9 event counter input DTD2: DTD2 signal output for debugging	PORT SIO T16 DBG
P93 #SRDY2 R/W DTD3	182	B2	I/O	*1	P93: General-purpose I/O port (default) #SRDY2: Serial I/F Ch.2 ready signal input/output R/W: Read/Write status output DTD3: DTD3 signal output for debugging	PORT SIO BBCU DBG
P94 SIN3 ACST DTD4	183	C4	I/O	*1	P94: General-purpose I/O port (default) SIN3: Serial I/F Ch.3 data input ACST: Bus access status output DTD4: DTD4 signal output for debugging	PORT SIO BBCU DBG
P95 SOUT3 ASTB DTD5	1	B1	I/O	*1	P95: General-purpose I/O port (default) SOUT3: Serial I/F Ch.3 data output ASTB: Address strobe output DTD5: DTD5 signal output for debugging	PORT SIO BBCU DBG
P96 #SCLK3 CARD4 DTD6	2	C2	I/O	*1	P96: General-purpose I/O port (default) #SCLK3: Serial I/F Ch.3 clock input/output CARD4: Card I/F signal 4 output (#OE or #CFCE1) DTD6: DTD6 signal output for debugging	PORT SIO CARD DBG
P97 #SRDY3 CARD5 DTD7	3	C1	I/O	*1	P97: General-purpose I/O port (default) #SRDY3: Serial I/F Ch.3 ready signal input/output CARD5: Card I/F signal 5 output (#WE or #CFCE2) DTD7: DTD7 signal output for debugging	PORT SIO CARD DBG

Debug Pin List

Pin name	Pin No.		I/O	Pull-up	Function	Module
	QFP	PFBGA				
DSIO	169	C5	I/O	Pull-up	Serial input/output for debugging	DBG
DCLK	176	A4	O (H)	–	DCLK signal output for debugging	DBG
DST2	172	D5	O (L)	–	DST2 signal output for debugging	DBG
DST0 P65	170	B5	I/O (H)	*1	DST0: DST0 signal output for debugging (default) P65: General-purpose I/O port	DBG PORT
DST1 P66	171	A5	I/O (H)	*1	DST1: DST1 signal output for debugging (default) P66: General-purpose I/O port	DBG PORT
DPCO P67	174	B4	I/O (H)	*1	DPCO: DPCO signal output for debugging (default) P67: General-purpose I/O port	DBG PORT

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Other Pin List

Pin name	Pin No.		I/O	Pull-up/down	Function	Module
	QFP	PFBGA				
OSC1	141	A13	I	–	Low speed (OSC1) oscillator input (32 kHz crystal or external clock input with V _{DD} level)	OSC
OSC2	142	A12	O	–	Low speed (OSC1) oscillator output	OSC
OSC3	149	A10	I	–	High speed (OSC3) oscillator input (crystal/ceramic or external clock input with V _{DD} level)	OSC
OSC4	150	A9	O	–	High speed (OSC3) oscillator output	OSC
VCP	144	C11	O	–	PLL analog monitor (used for current monitor)	CMU
CMU_CLK P63 BCLK T8UF5	28	H1	I/O	*1	CMU_CLK: CMU external clock output (default) P63: General-purpose I/O port BCLK: Bus clock output T8UF5: 8-bit timer 5 output	CMU PORT BBCU T8
#RESET	155	D8	I	Pull-up	Initial reset input pin	CMU
#NMI	156	B8	I	Pull-up	NMI request input pin	CMU
TST0	152	C9	I	Pull-down	Test input pin 0 (Connect to V _{SS} during normal operation)	–
TST1	153	B9	I	Pull-down	Test input pin 1 (Connect to V _{SS} during normal operation)	–
BURNIN	147	C10	I	–	Wafer level burn-in test enable input	–
SCANEN	148	B10	I	Pull-down	Scan test enable input	–
#STBY	140	B13	I	–	Standby input for disabling C33 operation (except RTC)	RTC

*1: These pins can have pull-ups enabled or disabled by setting the pin control registers. (Pull-ups are enabled by default.)

*2: These pins come with a bus hold latch.

Notes: • The # prefixed to pin names indicates that input/output signals of the pin are active low.

- The pin names and I/O printed in boldface denote the default pin (signal) name and default input/output direction.
- (H) and (L) for I/O indicate the default output level. This is only indicated for signals whose level is fixed high or low when the chip is initially reset.
- The input level must be V_{DD} only for the OSC1 and OSC3 pins. Input levels for other pins should be V_{DDE} (AV_{DD}, TMV_{DD}) level.

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